

NB100LVEP56

2.5V / 3.3V / 5V ECL Dual Differential 2:1 Multiplexer

The NB100LVEP56 is a dual, fully differential 2:1 multiplexer. The differential data path makes the device ideal for multiplexing low skew clock or differential data signals. The device features both individual and common select inputs to address both data path and random logic applications. Common and individual selects can accept both ECL and CMOS input voltage levels. Multiple V_{BB} pins are provided.

The V_{BB} pin, an internally generated voltage supply, is available to this device only. For single-ended input conditions, the unused differential input is connected to V_{BB} as a switching reference voltage. V_{BB} may also rebias AC coupled inputs. When used, decouple V_{BB} and V_{CC} via a 0.01 μ F capacitor and limit current sourcing or sinking to 0.5 mA. When not used, V_{BB} should be left open.

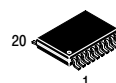
- 700 ps Typical Propagation Delays
- Maximum Frequency > 2.5 GHz Typical
- Low Profile QFN Package
- PECL Mode Operating Range: $V_{CC} = 2.375$ V to 5.5 V with $V_{EE} = 0$ V
- NECL Mode Operating Range: $V_{CC} = 0$ V with $V_{EE} = -2.375$ V to -5.5 V
- Separate, Common Select, and Individual Select (Compatible with ECL and CMOS Input Voltage Levels)
- Q Output Will Default LOW with Inputs Open or at V_{EE}
- Multiple V_{BB} Outputs



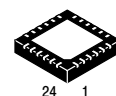
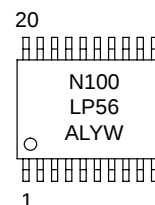
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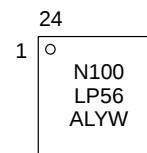
MARKING DIAGRAMS*



TSSOP-20
DT SUFFIX
CASE 948E



24 PIN QFN
MN SUFFIX
CASE 485L



A = Assembly Location
L = Wafer Lot
Y = Year
W = Work Week

*For additional information, see Application Note AND8002/D

ORDERING INFORMATION

Device	Package	Shipping
NB100LVEP56DT	TSSOP-20	75 Units/Rail
NB100LVEP56DTR2	TSSOP-20	2500 Tape & Reel
NB100LVEP56MN	QFN-24	93 Units/Rail
NB100LVEP56MNR2	QFN-24	3000 Tape & Reel

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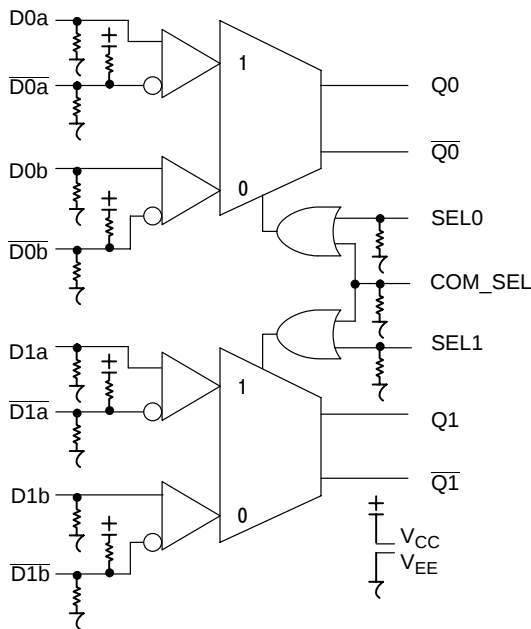


Figure 1. Logic Diagram

PIN DESCRIPTION

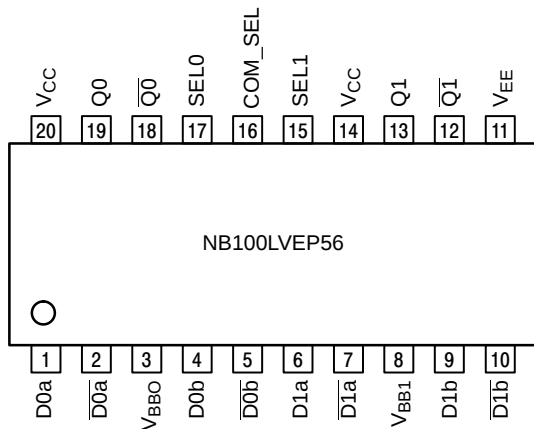
PIN	FUNCTION
D0a*, $\overline{D0a}$ *, D1a*, $\overline{D1a}$ *	ECL Input Data a
D0b*, $\overline{D0b}$ *, D1b*, $\overline{D1b}$ *	ECL Input Data b
SEL0**, SEL1**	CMOS/ECL Indiv. Select Input
COM_SEL**	CMOS/ECL Common Select Input
V _{BB0} , V _{BB1}	Output Reference Voltage
Q0 - Q1	ECL True Outputs
$\overline{Q0}$ - $\overline{Q1}$	ECL Inverted Outputs
V _{CC}	Positive Supply
V _{EE}	Negative Supply

* Pins will default differentially LOW when left open.

** Pins will default LOW when left open.

TRUTH TABLE

SEL0	SEL1	COM_SEL	Q0, $\overline{Q0}$	Q1, $\overline{Q1}$
X	X	H	a	a
L	L	L	b	b
L	H	L	b	a
H	H	L	a	a
H	L	L	a	b



Warning: All V_{CC} and V_{EE} pins must be externally connected to Power Supply to guarantee proper operation.

Figure 2. TSSOP-20 Lead Pinout (Top View)

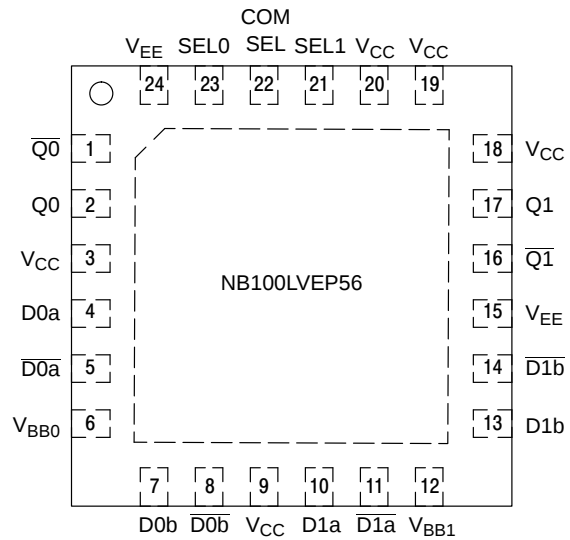


Figure 3. QFN-24 Lead Pinout (Top View)

ATTRIBUTES

Characteristics	Value
Internal Input Pulldown Resistor	75 k Ω
Internal Input Pullup Resistor	37 k Ω
ESD Protection	Human Body Model Machine Model Charged Device Model
	> 2 kV > 150 V > 2 kV
Moisture Sensitivity, Indefinite Time Out of Drypack (Note 1)	Level 1
Flammability Rating	Oxygen Index: 28 to 34 UL 94 V-0 @ 0.125 in
Transistor Count	354 Devices
Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test	

1. For additional information, see Application Note AND8003/D.

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MAXIMUM RATINGS (Note 2)

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V _{CC}	PECL Mode Power Supply	V _{EE} = 0 V		6	V
V _{EE}	NECL Mode Power Supply	V _{CC} = 0 V		-6	V
V _I	PECL Mode Input Voltage NECL Mode Input Voltage	V _{EE} = 0 V V _{CC} = 0 V	V _I ≤ V _{CC} V _I ≥ V _{EE}	6 -6	V V
I _{out}	Output Current	Continuous Surge		50 100	mA mA
I _{BB}	V _{BB} Sink/Source			± 0.5	mA
T _A	Operating Temperature Range			-40 to +85	°C
T _{stg}	Storage Temperature Range			-65 to +150	°C
θ _{JA}	Thermal Resistance (Junction-to-Ambient) JESD 51-3 (1S - Single Layer Test Board)	0 LFPM 500 LFPM	20 TSSOP 20 TSSOP	140 50	°C/W °C/W
θ _{JA}	Thermal Resistance (Junction-to-Ambient) JESD 51-6 (2S2P-Multi Layer Test Board) with Filled Thermal Vias	0 LFPM	24 QFN	47.3	°C/W
θ _{JC}	Thermal Resistance (Junction-to-Case)	std bd	20 TSSOP	23 to 41	°C/W
T _{sol}	Wave Solder	<2 to 3 sec @ 248°C		265	°C

2. Maximum Ratings are those values beyond which device damage may occur.

DC CHARACTERISTICS, PECL V_{CC} = 2.5 V, V_{EE} = 0 V (Note 3)

Symbol	Characteristic	-40 °C			25 °C			85 °C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
I _{EE}	Power Supply Current	35	45	55	35	45	55	35	48	58	mA
V _{OH}	Output HIGH Voltage (Note 4)	1355	1480	1605	1355	1480	1605	1355	1480	1605	mV
V _{OL}	Output LOW Voltage (Note 4)	555	775	900	555	775	900	555	775	900	mV
V _{IH}	Input HIGH Voltage (SEL0, SEL1, COM_SEL) Input HIGH Voltage (D Inputs) (Note 5)	1335 1335		V _{CC} 1620	1335 1335		V _{CC} 1620	1275 1275		V _{CC} 1620	mV
V _{IL}	Input LOW Voltage (SEL0, SEL1, COM_SEL) Input LOW Voltage (D Inputs) (Note 5)	V _{EE} 555		875 875	V _{EE} 555		875 875	V _{EE} 555		875 875	mV
V _{IHCMR}	Input HIGH Voltage Common Mode Range (Differential) (Note 6)	1.2		2.5	1.2		2.5	1.2		2.5	V
I _{IH}	Input HIGH Current			150			150			150	μA
I _{IL}	Input LOW Current D D̄ SEL	0.5 -150 -150			0.5 -150 -150			0.5 -150 -150			μA

NOTE: LVEP circuits are designed to meet the DC specifications shown in the above table after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500 lfpm is maintained.

- Input and output parameters vary 1:1 with V_{CC}. V_{EE} can vary +0.125 V to -1.3 V.
- All loading with 50 Ω to V_{CC}-2.0 volts.
- Do not use V_{BB} at V_{CC} < 3.0 V.
- V_{IHCMR} min varies 1:1 with V_{EE}, V_{IHCMR} max varies 1:1 with V_{CC}. The V_{IHCMR} range is referenced to the most positive side of the differential input signal.

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DC CHARACTERISTICS, PECL $V_{CC} = 3.3\text{ V}$, $V_{EE} = 0\text{ V}$ (Note 7)

Symbol	Characteristic	-40 °C			25 °C			85 °C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
I_{EE}	Power Supply Current	35	45	55	35	45	55	35	48	58	mA
V_{OH}	Output HIGH Voltage (Note 8)	2155	2280	2405	2155	2280	2405	2155	2280	2405	mV
V_{OL}	Output LOW Voltage (Note 8)	1355	1575	1700	1355	1575	1700	1355	1575	1700	mV
V_{IH}	Input HIGH Voltage (SEL0, SEL1, COM_SEL) Input HIGH Voltage (D Inputs)	2135 2135		V_{CC} 2420	2135 2135		V_{CC} 2420	2135 2135		V_{CC} 2420	mV
V_{IL}	Input LOW Voltage (SEL0, SEL1, COM_SEL) Input LOW Voltage (D Inputs)	V_{EE} 1355		1675 1675	V_{EE} 1355		1675 1675	V_{EE} 1355		1675 1675	mV
V_{BB}	Output Reference Voltage (Note 9)	1775	1875	1975	1775	1875	1975	1775	1875	1975	mV
V_{IHCMR}	Input HIGH Voltage Common Mode Range (Differential) (Note 10)	1.2		3.3	1.2		3.3	1.2		3.3	V
I_{IH}	Input HIGH Current			150			150			150	μA
I_{IL}	Input LOW Current D $\bar{D}$ SEL	0.5 -150 -150			0.5 -150 -150			0.5 -150 -150			μA

NOTE: LVEP circuits are designed to meet the DC specifications shown in the above table after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500 lfm is maintained.

7. Input and output parameters vary 1:1 with V_{CC} . V_{EE} can vary +0.925 V to -0.5 V.

8. All loading with 50 Ω to V_{CC} -2.0 volts.

9. Single-Ended input operation is limited to $V_{CC} \geq 3.0\text{ V}$ in PECL mode.

10. V_{IHCMR} min varies 1:1 with V_{EE} , V_{IHCMR} max varies 1:1 with V_{CC} . The V_{IHCMR} range is referenced to the most positive side of the differential input signal.

DC CHARACTERISTICS, PECL $V_{CC} = 5.0\text{ V}$, $V_{EE} = 0\text{ V}$ (Note 11)

Symbol	Characteristic	-40 °C			25 °C			85 °C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
I_{EE}	Power Supply Current	40	50	60	40	50	60	45	55	65	mA
V_{OH}	Output HIGH Voltage (Note 12)	3855	3980	4105	3855	3980	4105	3855	3980	4105	mV
V_{OL}	Output LOW Voltage (Note 12)	3055	3275	3400	3055	3275	3400	3055	3275	3400	mV
V_{IH}	Input HIGH Voltage (SEL0, SEL1, COM_SEL) Input HIGH Voltage (D Inputs)	3775 3775		V_{CC} 4120	3775 3775		V_{CC} 4120	3775 3775		V_{CC} 4120	mV
V_{IL}	Input LOW Voltage (SEL0, SEL1, COM_SEL) Input LOW Voltage (D Inputs)	V_{EE} 3055		3375 3375	V_{EE} 3055		3375 3375	V_{EE} 3055		3375 3375	mV
V_{BB}	Output Voltage Reference	3475	3575	3675	3475	3575	3675	3475	3575	3675	mV
V_{IHCMR}	Input HIGH Voltage Common Mode Range (Differential) (Note 13)	1.2		5.0	1.2		5.0	1.2		5.0	V
I_{IH}	Input HIGH Current			150			150			150	μA
I_{IL}	Input LOW Current D $\bar{D}$ SEL	0.5 -150 -150			0.5 -150 -150			0.5 -150 -150			μA

NOTE: EP circuits are designed to meet the DC specifications shown in the above table after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500 lfm is maintained.

11. Input and output parameters vary 1:1 with V_{CC} . V_{EE} can vary +2.0 V to -0.5 V.

12. All loading with 50 ohms to V_{CC} -2.0 volts.

13. V_{IHCMR} min varies 1:1 with V_{EE} , V_{IHCMR} max varies 1:1 with V_{CC} . The V_{IHCMR} range is referenced to the most positive side of the differential input signal.

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DC CHARACTERISTICS, NECL $V_{CC} = 0\text{ V}$, $V_{EE} = -3.8\text{ V}$ to -2.375 V (Note 14)

Symbol	Characteristic	-40 °C			25 °C			85 °C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
I_{EE}	Power Supply Current	35	45	55	35	45	55	35	48	58	mA
V_{OH}	Output HIGH Voltage (Note 15)	-1 145	-1020	-895	-1 145	-1020	-895	-1 145	-1020	-895	mV
V_{OL}	Output LOW Voltage (Note 15)	-1945	-1725	-1600	-1945	-1725	-1600	-1945	-1725	-1600	mV
V_{IH}	Input HIGH Voltage (SEL0, SEL1, COM_SEL) Input HIGH Voltage (D Inputs)	-1 165		V_{CC}	-1 165		V_{CC}	-1 165		V_{CC}	mV
		-1 165		-880	-1 165		-880	-1 165		-880	
V_{IL}	Input LOW Voltage (SEL0, SEL1, COM_SEL) Input LOW Voltage (D Inputs)	V_{EE}		-1600	V_{EE}		-1600	V_{EE}		-1600	mV
		-1945		-1600	-1945		-1600	-1945		-1600	
V_{BB}	Output Reference Voltage (Note 16)	-1525	-1425	-1325	-1525	-1425	-1325	-1525	-1425	-1325	mV
V_{IHCMR}	Input HIGH Voltage Common Mode Range (Differential) (Note 17)	$V_{EE}+1.2$		0.0	$V_{EE}+1.2$		0.0	$V_{EE}+1.2$		0.0	V
I_{IH}	Input HIGH Current			150			150			150	μA
I_{IL}	Input LOW Current D $\bar{D}$ SEL	0.5			0.5			0.5			μA
		-150			-150			-150			
		-150			-150			-150			

NOTE: LVEP circuits are designed to meet the DC specifications shown in the above table after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500 lfm is maintained.

14. Input and output parameters vary 1:1 with V_{CC} .

15. All loading with 50 Ω to $V_{CC}-2.0$ volts.

16. Single-Ended input operation is limited to V_{EE} from -3.0 V to -5.5 V in NECL mode.

17. V_{IHCMR} min varies 1:1 with V_{EE} , V_{IHCMR} max varies 1:1 with V_{CC} . The V_{IHCMR} range is referenced to the most positive side of the differential input signal.

DC CHARACTERISTICS, NECL $V_{CC} = 0\text{ V}$, $V_{EE} = -3.8\text{ V}$ to -5.5 V (Note 18)

Symbol	Characteristic	-40 °C			25 °C			85 °C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
I_{EE}	Power Supply Current	40	50	60	40	50	60	45	55	65	mA
V_{OH}	Output HIGH Voltage (Note 19)	-1 145	-1020	-895	-1 145	-1020	-895	-1 145	-1020	-895	mV
V_{OL}	Output LOW Voltage (Note 19)	-1945	-1725	-1600	-1945	-1725	-1600	-1945	-1725	-1600	mV
V_{IH}	Input HIGH Voltage (SEL0, SEL1, COM_SEL) Input HIGH Voltage (D Inputs)	-1 165		V_{CC}	-1 165		V_{CC}	-1 165		V_{CC}	mV
		-1 165		-880	-1 165		-880	-1 165		-880	
V_{IL}	Input LOW Voltage (SEL0, SEL1, COM_SEL) Input LOW Voltage (D Inputs)	V_{EE}		-1600	V_{EE}		-1600	V_{EE}		-1600	mV
		-1945		-1625	-1945		-1625	-1945		-1625	
V_{BB}	Output Reference Voltage (Note 20)	-1525	-1425	-1325	-1525	-1425	-1325	-1525	-1425	-1325	mV
V_{IHCMR}	Input HIGH Voltage Common Mode Range (Differential) (Note 21)	$V_{EE}+1.2$		0.0	$V_{EE}+1.2$		0.0	$V_{EE}+1.2$		0.0	V
I_{IH}	Input HIGH Current			150			150			150	μA
I_{IL}	Input LOW Current D $\bar{D}$ SEL	0.5			0.5			0.5			μA
		-150			-150			-150			
		-150			-150			-150			

NOTE: LVEP circuits are designed to meet the DC specifications shown in the above table after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500 lfm is maintained.

18. Input and output parameters vary 1:1 with V_{CC} .

19. All loading with 50 Ω to $V_{CC}-2.0$ volts.

20. Single-Ended input operation is limited to V_{EE} from -3.0 V to -5.5 V in NECL mode.

21. V_{IHCMR} min varies 1:1 with V_{EE} , V_{IHCMR} max varies 1:1 with V_{CC} . The V_{IHCMR} range is referenced to the most positive side of the differential input signal.

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AC CHARACTERISTICS $V_{CC} = 0\text{ V}$; $V_{EE} = -2.375\text{ V}$ to -3.8 V or $V_{CC} = 2.375\text{ V}$ to 3.8 V ; $V_{EE} = 0\text{ V}$ (Note 22)

Symbol	Characteristic	-40 °C			25 °C			85 °C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
V_{opp}	Output Voltage Amplitude (See Figure 4) $f_{in} < 1\text{ GHz}$ $f_{in} = 2\text{ GHz}$ $f_{in} = 2.5\text{ GHz}$	525 500 400	700 600 500		550 500 350	700 600 450		500 400 200	700 500 300		mV
t_{PLH} , t_{PHL}	Propagation Delay to Output Differential D to Q, $\bar{Q}$ SEL to Q, $\bar{Q}$ COM_SEL to Q, $\bar{Q}$	375 575 550	500 775 750	625 975 950	400 625 600	525 825 800	650 1025 1000	450 700 700	575 900 900	700 1100 1100	ps
t_{skew}	Pulse Skew (Note 23) Within Device Input Skew (Note 24) Within Device Output Skew (Note 25) Device-to-Device Skew (Note 26)		10 5 15 50	50 30 50 200		10 5 15 50		10 5 15 50	50 30 50 200		ps
t_{JITTER}	RMS Random Clock Jitter $f_{in} = 2.5\text{ GHz}$ (Note 27) Peak-to-Peak Data Dependent Jitter $f_{in} = 1.5\text{ Gbps}$ (Note 28) $f_{in} = 2.5\text{ Gbps}$			1			1			1	ps
V_{PP}	Input Voltage Swing (Note 29)	150	800	1200	150	800	1200	150	800	1200	mV
t_r t_f	Output Rise/Fall Times (20% - 80%) Q, $\bar{Q}$	60	110	150	60	120	170	90	140	230	ps

22. Measured using a 750 mV source, 50% duty cycle clock source. All loading with 50 Ω to $V_{CC}-2.0\text{ V}$.

23. Pulse Skew $|t_{PLH} - t_{PHL}|$

24. Worst case difference between D0a and D0b (or between D1a or D1b), when both output come from same input.

25. Worst case difference between Q0 and Q1 outputs.

26. Skew is measured between outputs under identical transitions.

27. Additive RMS jitter with 50% Duty Cycle Clock Signal at 3 GHz.

28. Additive Peak-to-Peak jitter with input NRZ data at PRBS $2^{31}-1$ at 3 Gbps.

29. Input voltage swing is a single-ended measurement operating in differential mode.

AC CHARACTERISTICS $V_{CC} = 0\text{ V}$; $V_{EE} = -4.2\text{ V}$ to -5.5 V or $V_{CC} = 4.2\text{ V}$ to 5.5 V ; $V_{EE} = 0\text{ V}$ (Note 30)

Symbol	Characteristic	-40 °C			25 °C			85 °C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
V_{opp}	Output Voltage Amplitude (See Figure 5) $f_{in} < 1\text{ GHz}$ $f_{in} = 2\text{ GHz}$ $f_{in} = 2.5\text{ GHz}$	600 550 400	750 650 550		600 500 350	750 600 450		600 400 200	750 500 300		mV
t_{PLH} , t_{PHL}	Propagation Delay to Output Differential D to Q, $\bar{Q}$ SEL to Q, $\bar{Q}$ COM_SEL to Q, $\bar{Q}$	375 575 550	500 775 750	625 975 950	400 625 600	525 825 800	650 1025 1000	450 700 700	575 900 900	700 1100 1100	ps
t_{skew}	Pulse Skew (Note 31) Within Device Input Skew (Note 32) Within Device Output Skew (Note 33) Device-to-Device Skew (Note 34)		5 15 20 50	50 30 50 200		5 15 20 50	50 30 50 200		5 15 20 50	50 30 50 200	ps
t_{JITTER}	RMS Random Clock Jitter $f_{in} = 2.5\text{ GHz}$ (Note 35) Peak-to-Peak Data Dependent Jitter $f_{in} = 1.5\text{ Gbps}$ (Note 36) $f_{in} = 2.5\text{ Gbps}$			1			1			1	ps
V_{PP}	Input Voltage Swing (Note 37)	150	800	1200	150	800	1200	150	800	1200	mV
t_r t_f	Output Rise/Fall Times (20% - 80%) Q, $\bar{Q}$	60	110	150	60	120	170	90	140	230	ps

30. Measured using a 750 mV source, 50% duty cycle clock source. All loading with 50 Ω to $V_{CC}-2.0\text{ V}$.

31. Pulse Skew $|t_{PLH} - t_{PHL}|$

32. Worst case difference between D0a and D0b (or between D1a or D1b), when both output come from same input.

33. Worst case difference between Q0 and Q1 outputs.

34. Skew is measured between outputs under identical transitions.

35. Additive RMS jitter with 50% Duty Cycle Clock Signal at 3 GHz.

36. Additive Peak-to-Peak jitter with input NRZ data at PRBS $2^{31}-1$ at 3 Gbps.

37. Input voltage swing is a single-ended measurement operating in differential mode.

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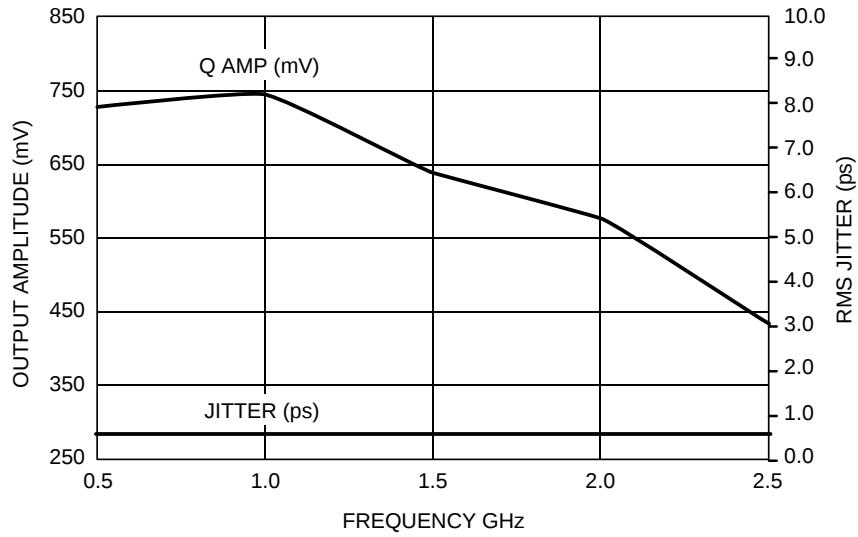


Figure 4. Typical Output Voltage (V_{opp}) versus Input Frequency (f_{in}) at $V_{CC} = 2.5\text{ V}$, 25°C

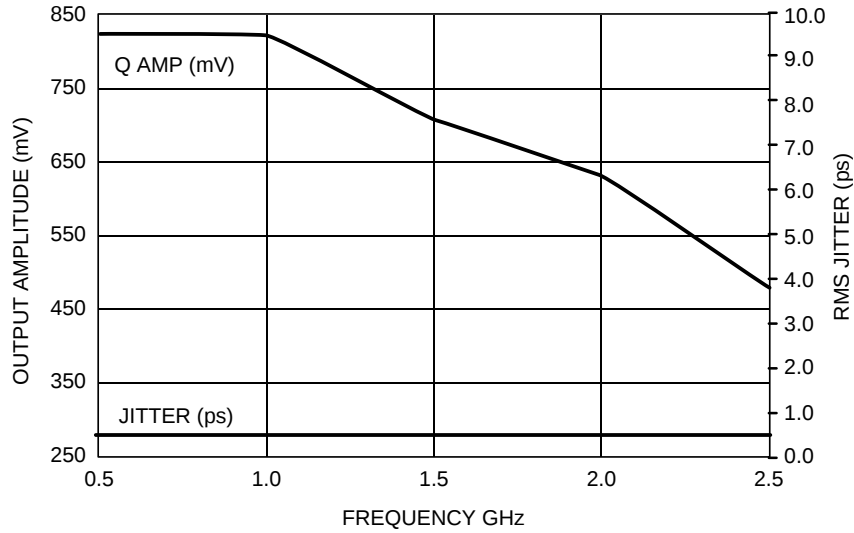


Figure 5. Typical Output Voltage (V_{opp}) versus Input Frequency (f_{in}) at $V_{CC} = 5.0\text{ V}$, 25°C

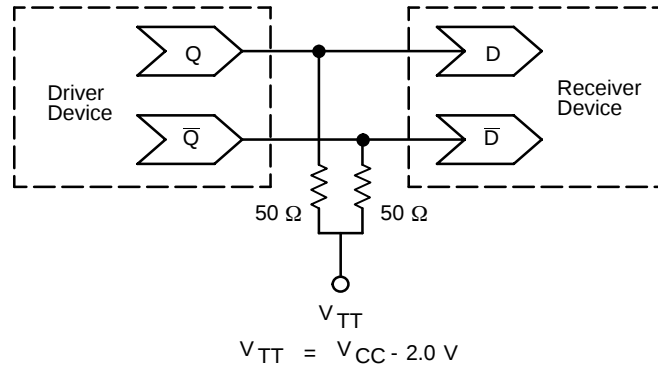


Figure 6. Typical Termination for Output Driver and Device Evaluation
(See Application Note AND8020 - Termination of ECL Logic Devices.)

Resource Reference of Application Notes

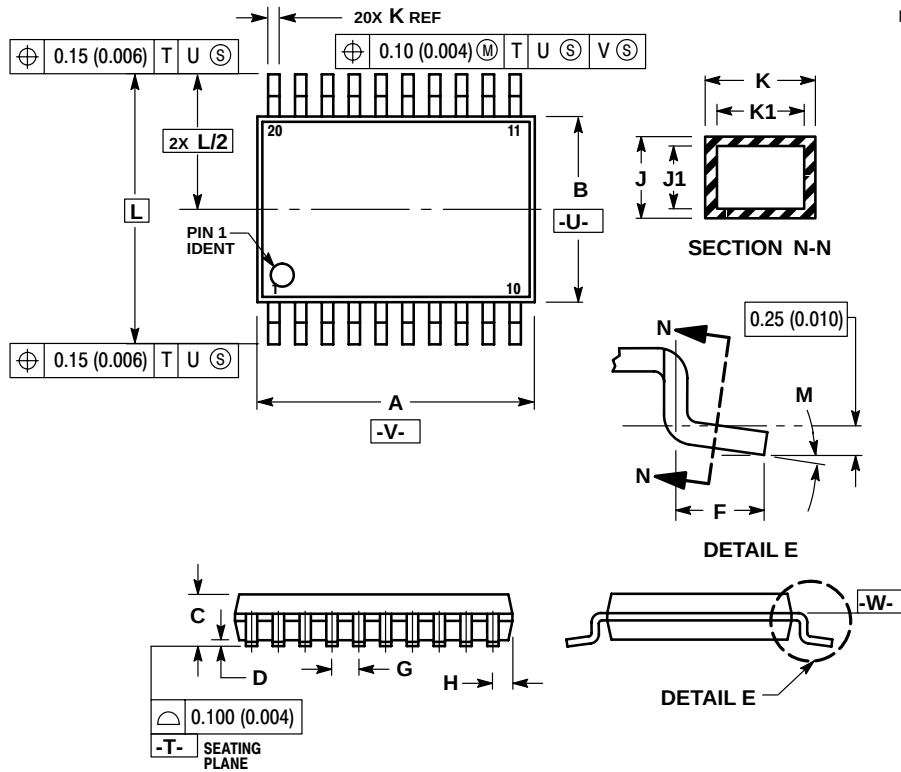
- AN1404** - ECLinPS Circuit Performance at Non-Standard V_{IH} Levels
- AN1405** - ECL Clock Distribution Techniques
- AN1406** - Designing with PECL (ECL at +5.0 V)
- AN1504** - Metastability and the ECLinPS Family
- AN1568** - Interfacing Between LVDS and ECL
- AN1672** - The ECL Translator Guide
- AND8002** - Marking and Date Codes
- AND8009** - ECLinPS Plus Spice I/O Model Kit
- AND8020** - Termination of ECL Logic Devices

For an updated list of Application Notes, please see our website at <http://onsemi.com>.

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PACKAGE DIMENSIONS

TSSOP-20
DT SUFFIX
PLASTIC TSSOP PACKAGE
CASE 948E-02
ISSUE A



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	6.40	6.60	0.252	0.260
B	4.30	4.50	0.169	0.177
C	---	1.20	---	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC		0.026 BSC	
H	0.27	0.37	0.011	0.015
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC		0.252 BSC	
M	0°	8°	0°	8°

Notes

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